CH7028 TV Encoder

Features

- TV encoder targets for handheld device and surveillance camera
- Supports multiple output formats such as analog TV (NTSC and PAL). Sync signals can be provided in separated or composite manner.
- Two on-chip 10-bit high speed DACs providing flexible output capabilities such as single or simultaneous CVBS and S-video outputs.
- 90/180/270 degree image rotation and vertical or horizontal flip.
- 16-Mbit SDRAM is used as a frame buffer for frame rate conversion.
- Flexible up and down scaling.
- Programmable 24-bit/18-bit/16-bit/15-bit/12-bit/8-bit digital input interface supports various RGB (RGB888, RGB666, RGB565 and etc), YCbCr (4:4:4 YCbCr, ITU656) and 2x or 3x multiplexed input. CPU interface is also supported.
- Supports flexible input resolution up to 800x800 and 1024x680.
- Pixel by pixel brightness, contrast, hue and saturation adjustment for each output is supported.
- Pixel by pixel horizontal position adjustment and line by line vertical position adjustment.
- TV/Monitor connection detection capability. DAC can be switched off based on detection result.
- Programmable power management.
- Flexible pixel clock frequency from graphics controller is supported. (2.3MHz –120MHz)
- Flexible input clock from crystal or oscillator is supported. (2.3MHz – 64MHz)
- Supports slave input clock mode only.
- Fully programmable through serial port.
- IO and SPC/SPD voltage supported is from 1.2V to 3.3V.
- Offered in a 64-pin LQFP package.

General Description

The CH7028 is a semiconductor device targeting for surveillance system and consumer product for handheld market. This device accepts digital video signals through its 24-bit input bus and generates NTSC, PAL video signal by its 10-bit DACs. In addition, CH7028 has an embedded 16-Mbit SDRAM to support the CPU interface.

CH7028 has incorporated an advanced technology that can perform real-time video rotations and frame rate conversions for incoming video stream. These complicated tasks are achieved by storing video data into the internal SDRAM and applying scaling process if required. CH7028 provides great flexibility for accepting different video data formats including RGB and YCbCr (e.g. RGB565, RGB 666, RGB 888, ITU 656).

Note: the above feature list is subject to change without notice. Please contact Chrontel for more information and current updates.

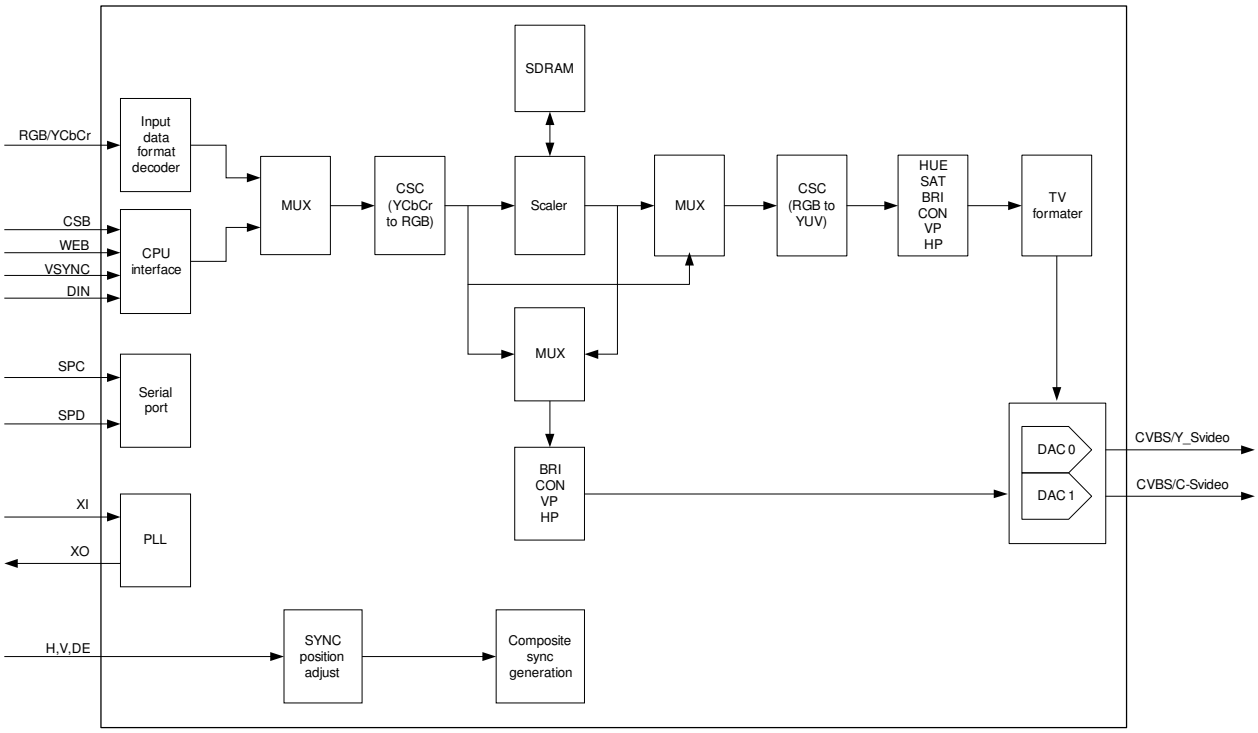

Figure 1: CH7028 block diagram

1.0 Pin-out

1.1 Package diagram

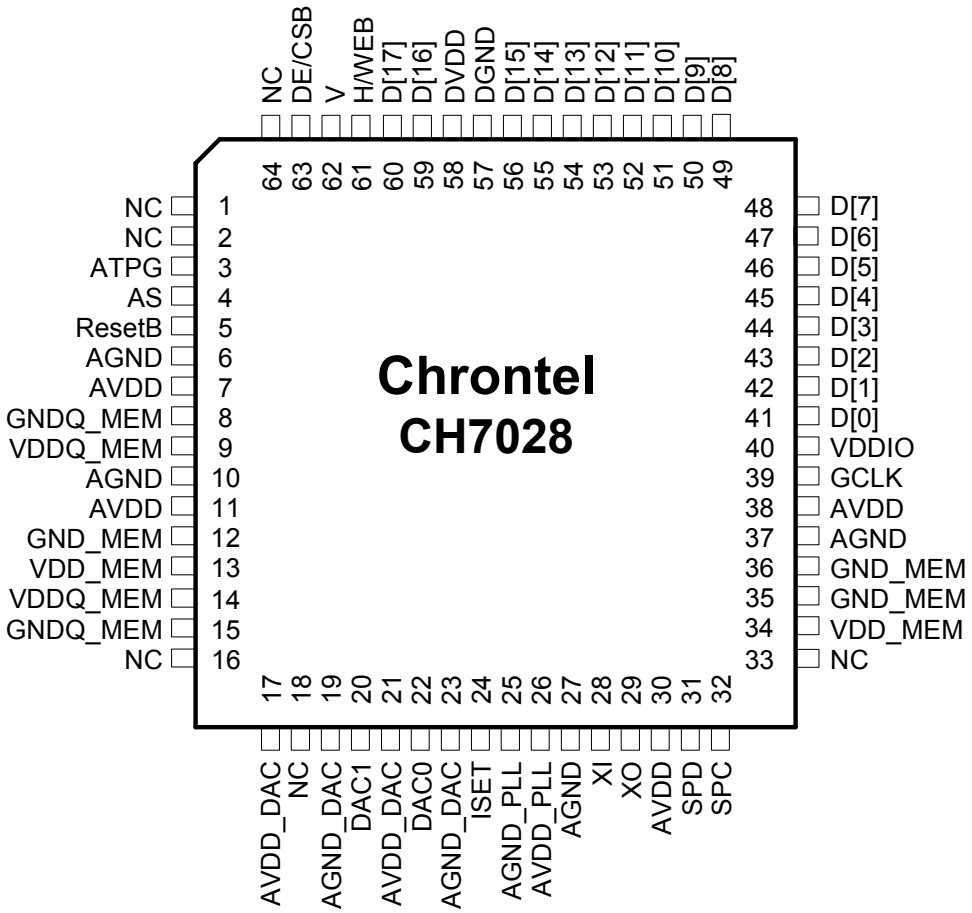

Figure 2: 64 pin LQFP package

1.2 Pin description

Table 1: Pin name descriptions (LQFP64 package)

Pin #	Type	Symbol	Description
41 - 56 59 - 60	In	D[17:0]	Data[0] through Data[17] Inputs These pins accept the 18 data inputs from a digital video port of a graphics controller. The swing is defined by VDDIO.
62	I/O	V	Vertical Sync Input / Output When the SYO control bit is low, this pin accepts a vertical sync input for use with the input data. The amplitude will be 0 to VDDIO. When the SYO control bit is high, the device will output a vertical sync pulse. The output is driven from the VDDIO supply.
61	I/O	H/WEB	Horizontal Sync Input / Output When the SYO control bit is low, this pin accepts a horizontal sync input for use with the input data. The amplitude will be 0 to VDDIO. When the SYO control bit is high, the device will output a horizontal sync pulse. The output is driven from the VDDIO supply. It is also the WEB signal of CPU interface.
63	In	DE/CSB	Data Input Indicator When the pin is high, the input data is active. When the pin is low, the input data is blanking. CSB signal input of CPU interface The amplitude will be 0 to VDDIO.
4	In	AS	Chip address select 0: 76h 1: 75h
3	In	ATPG	ATPG Enable (Internally pull-down) This pin should be left open or pulled low with a 10k resistor in the application. This pin configures the pre-condition for scan chain and boundary scan test when high. Otherwise it should be low. Voltage level is 0 to 3.3V.
5	In	ResetB	Reset * Input When this pin is low, the device is held in the power-on reset condition. When this pin is high, reset is controlled through the serial port.
31	I/O	SPD	Serial Port Data Input / Output This pin functions as the bi-directional data pin of the serial port. External pull-up resister is required.
32	In	SPC	Serial Port Clock Input This pin functions as the clock pin of the serial port. External pull-up resister is required.
22	Out	DAC0	CVBS or S-video output Full swing is up to 1.3v
20	Out	DAC1	CVBS or S-video output Full swing is up to 1.3v
24	In	ISET	Current Set Resistor Input This pin sets the DAC current. A 1.2k ohm, 1% tolerance resistor should be connected between this pin and AGND_DAC using short and wide traces.
28	In	XI	Crystal Input / External Reference Input For master mode and some situation of the slave mode, a parallel resonance crystal (± 20 ppm) should be attached between this pin and XO. However, an external 3.3V CMOS compatible clock can drive the XI/FIN input.

Pin #	Type	Symbol	Description
29	Out	XO	Crystal Output For master mode and some situation of the slave mode, a parallel resonance crystal (± 20 ppm) should be attached between this pin and XI / FIN. However, if an external CMOS clock is attached to XI/FIN, XO should be left open.
39	In	GCLK	External Clock Inputs The input is the clock signal input to the device for use with the H, V, DE and D[17:0] data.
40	Power	VDDIO	IO supply voltage (1.2-3.3V).
58	Power	DVDD	Digital supply voltage (1.8V)
7,11,30,38	Power	AVDD	Analog supply voltage
26	Power	AVDD_PLL	PLL supply voltage
17,21	Power	AVDD_DAC	DAC power supply
9,14	Power	VDDQ_MEM	SDRAM output buffer supply voltage
13,34	Power	VDD_MEM	SDRAM device supply voltage
57	Power	DGND	Digital supply ground
6,10,27,37	Power	AGND	Analog supply ground
25	Power	AGND_PLL	PLL supply ground
19,23	Power	AGND_DAC	DAC supply ground
8,15	Power	GNDQ_MEM	SDRAM output buffer supply ground
12,35,36	Power	GND_MEM	SDRAM device supply ground

2.0 Package Dimensions

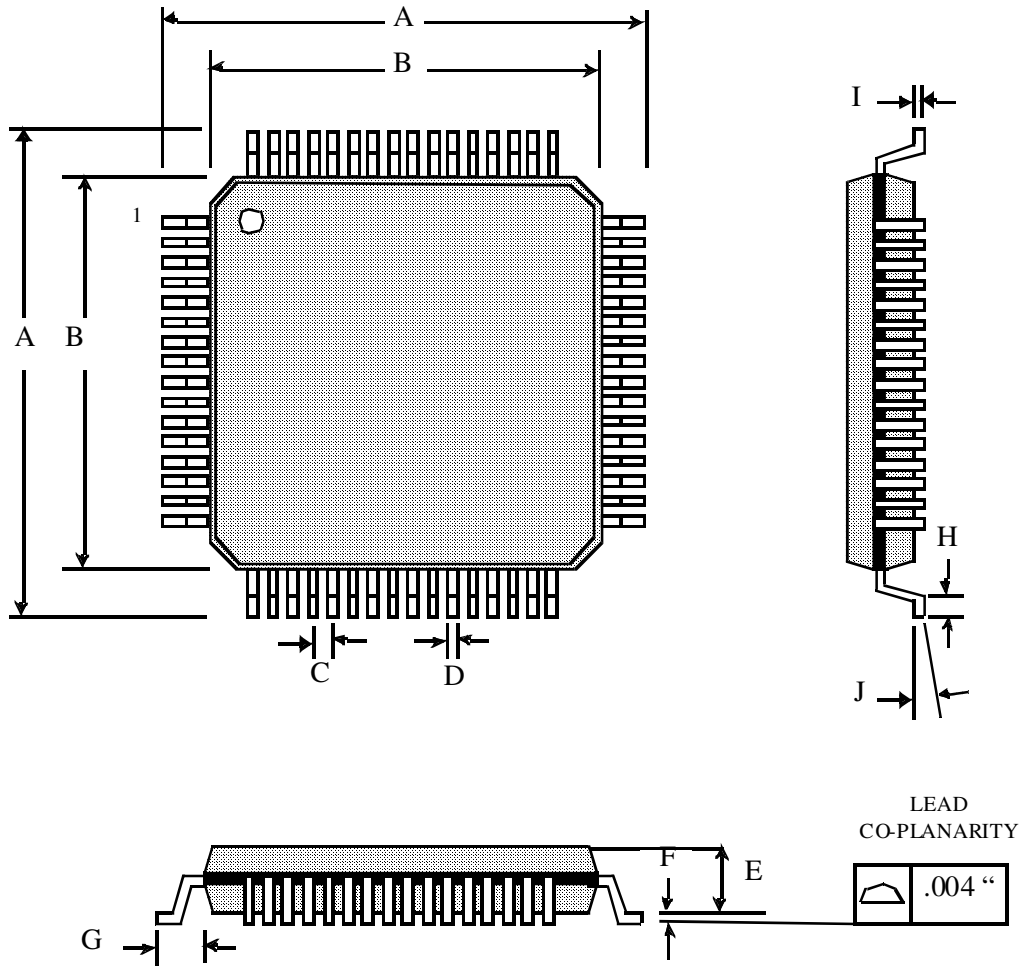

Figure 3: 64 Pin LQFP Package

Table of Dimensions

No. of Leads		SYMBOL									
64 (10 X 10 mm)		A	B	C	D	E	F	G	H	I	J
Milli-meters	MIN	12	10	0.50	0.17	1.35	0.05	1.00	0.45	0.09	0°
	MAX				0.27	1.45	0.15		0.75	0.20	7°

Notes:

1. Conforms to JEDEC standard JESD-30 MS-026D.
2. Dimension B: Top Package body size may be smaller than bottom package size by as much as 0.15 mm.
3. Dimension B does not include allowable mold protrusions up to 0.25 mm per side.

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ORDERING INFORMATION

Part Number	Package Type	Copy Protection	Operating Temperature Range
CH7028B-TF	64LQFP, Lead-free	None	Commercial : -20 to 70°C
CH7028B-TF-TR	64LQFP, Lead-free, Tape & Reel.	None	Commercial : -20 to 70°C

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